

N0604N

N-channel MOSFET 60 V, 82 A, 6.5 m Ω

R07DS0850EJ0200 Rev.2.00 2020.6.10

Features

• Low on-state resistance : $R_{DS (on)}$ = 6.5 m Ω MAX. (V_{GS} = 10 V, I_D = 41 A)

Low C_{iss}: C_{iss} = 4150 pF TYP. (V_{DS} = 25 V, V_{GS} = 0 V)

• High current : I_{D(DC)} = ±82 A

RoHS Compliant

· Quality Grade: Standard

• Applications : For high current switching

Ordering Information

Part No.	Package	Packing
N0604N-S19-AY	TO-220AB, Pb-free Note1	50 pcs / Magazine (Tube)

Note: 1. Pb-free means that this product does not contain lead in the external electrode.

Absolute Maximum Ratings ($T_A = 25^{\circ}C$)

Item	Symbol Ratings		Unit
Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	60	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±20	V
Drain Current (DC) (Tc = 25 °C)	I _{D(DC)}	±82	Α
Drain Current (pulse) Note2	I _{D(pulse)}	±200	Α
Total Power Dissipation (T _C = 25°C)	P _{T1}	116	W
Total Power Dissipation (T _A = 25°C)	P _{T2}	1.5	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C
Single Avalanche Current Note3	I _{AS}	35	Α
Single Avalanche Energy Note3	Eas	125	mJ

Note: Continuous heavy condition (e.g. high temperature/voltage/current or high variation of temperature) may affect a reliability even if it is within the absolute maximum ratings. Please consider derating condition for appropriate reliability in reference Renesas Semiconductor Reliability Handbook (Recommendation for Handling and Usage of Semiconductor Devices) and individual reliability data.

Notes: 2. PW \leq 10 μ s, Duty Cycle \leq 1%

3. Starting T_{ch} = 25°C, R_G = 25 Ω , V_{DD} = 30 V, V_{GS} = 20 \rightarrow 0 V, L = 100 μ H

Thermal Resistance

Item	Symbol	Max. Value Note4	Unit
Channel to Case Thermal Resistance	R _{th(ch-C)}	1.08	°C/W
Channel to Ambient Thermal Resistance	R _{th(ch-A)}	83.3	°C/W

Notes: 4. This data is the designed target maximum value on Renesas's measurement condition. (Not tested)

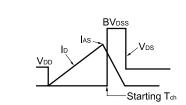
Electrical Characteristics (T_A = 25°C)

Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}			1	μA	V _{DS} = 60 V, V _{GS} = 0 V
Gate Leakage Current	Igss			±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Gate to Source Cut-off Voltage	V _{GS(off)}	2.0		4.0	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Forward Transfer Admittance Note5	yfs	30			S	$V_{DS} = 5 \text{ V}, I_{D} = 41 \text{ A}$
Drain to Source On-state Resistance Note5	R _{DS(on)}		5.1	6.5	mΩ	V _{GS} = 10 V, I _D = 41 A
Input Capacitance	Ciss		4150		pF	V _{DS} = 25 V,
Output Capacitance	Coss		310		pF	V _{GS} = 0 V,
Reverse Transfer Capacitance	Crss		165		pF	f = 1 MHz
Turn-on Delay Time	t _{d(on)}		24		ns	$V_{DD} = 30 \text{ V}, I_D = 41 \text{ A},$
Rise Time	t _r		8		ns	V _{GS} = 10 V,
Turn-off Delay Time	$t_{d(off)}$		64		ns	$R_G = 0 \Omega$
Fall Time	t _f		7		ns	
Total Gate Charge	Q_{G}		75		nC	$V_{DD} = 48 \text{ V},$
Gate to Source Charge	Q _{GS}		21		nC	V _{GS} = 10 V,
Gate to Drain Charge	Q_{GD}		21		nC	I _D = 82 A
Body Diode Forward Voltage Note5	V _{F(S-D)}			1.5	V	I _F = 82 A, V _{GS} = 0 V
Reverse Recovery Time	t _{rr}		38		ns	I _F = 82 A, V _{GS} = 0 V,
Reverse Recovery Charge	Qrr		39		nC	di/dt = 100 A/μs

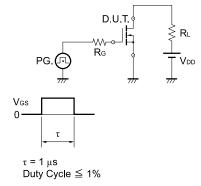
Notes: 5. Pulsed test

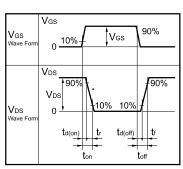
TEST CIRCUIT 1 AVALANCHE CAPABILITY

$\begin{array}{c} \text{D.U.T.} \\ \text{Rg} = 25 \ \Omega \\ \text{V} \\ \text{VGS} = 20 \text{ to } 0 \text{ V} \end{array}$



TEST CIRCUIT 2 SWITCHING TIME





TEST CIRCUIT 3 GATE CHARGE

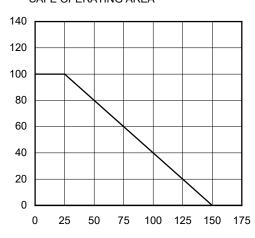
$$\begin{array}{c|c} D.U.T. \\ \hline I_G = 2 \text{ mA} \\ \hline \end{array} \begin{array}{c} RL \\ \hline \end{array}$$

dT - Percentage of Rated Power - %

lo - Drain Current - A

Typical Characteristics

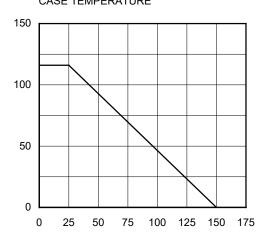
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



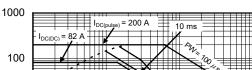
T_C - Case Temperature - °C FORWARD BIAS SAFE OPERATING AREA

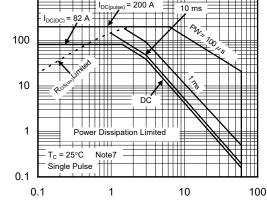
P_{T} - Total Power Dissipation – W

TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



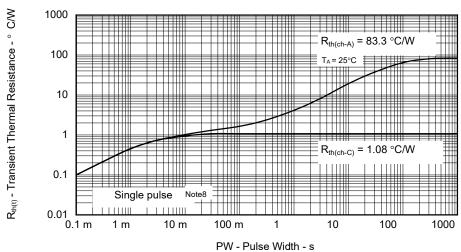
 T_{C} - Case Temperature - $^{\circ}\text{C}$





V_{DS} - Drain to Source Voltage - V

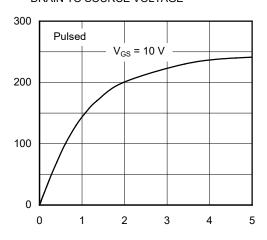
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



Notes: 6. Designed target value on Renesas measurement condition. (T_C = 25°C, unless otherwise specified)

- 7. This data is the designed value on Renesas's measurement condition. Renesas recommends that operating conditions are designed according to a document "Power MOSFET/IGBT Attention of Handling Semiconductor Devices (R07ZZ0010)".
- 8. This data is the designed target maximum value on Renesas's measurement condition.

DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



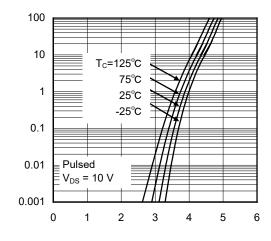
 V_{DS} - Drain to Source Voltage - V

FORWARD TRANSFER CHARACTERISTICS

I_D - Drain Current - A

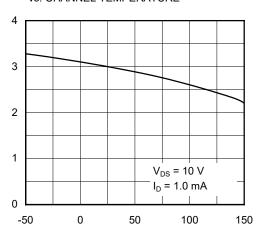
| yfs | - Forward Transfer Admittance - S

 $R_{\text{DS}(\text{on})}$ - Drain to Source On-state Resistance - $m\Omega$



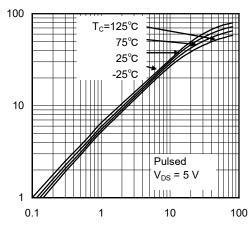
V_{GS} - Gate to Source Voltage - V

GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



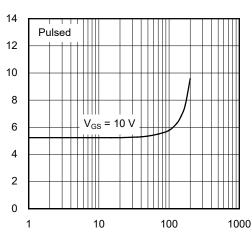
T_{ch} - Channel Temperature - °C

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



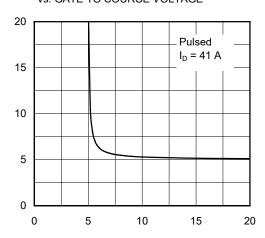
I_D - Drain Current - A

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

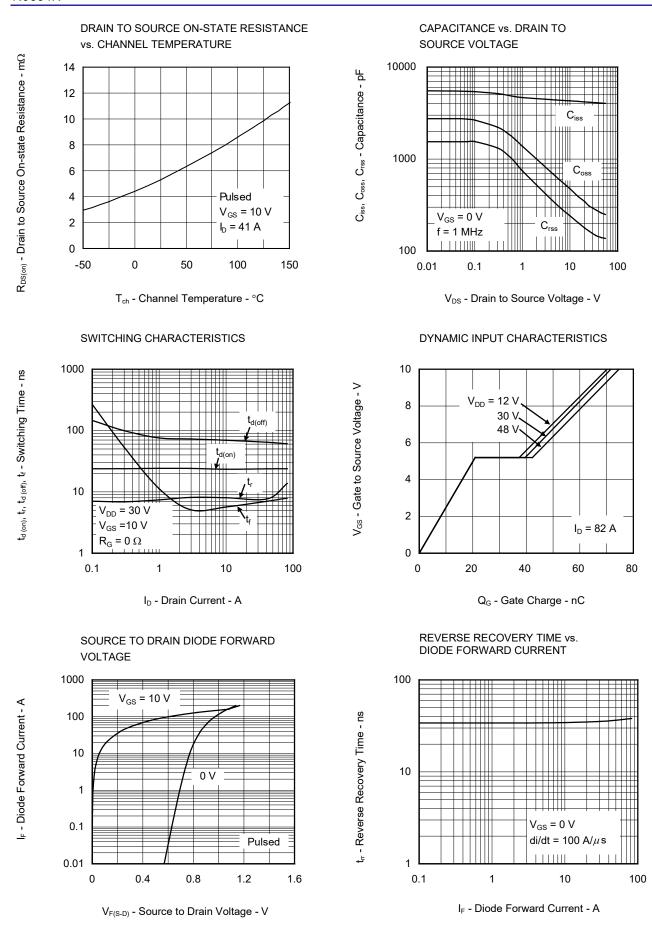


I_D - Drain Current - A

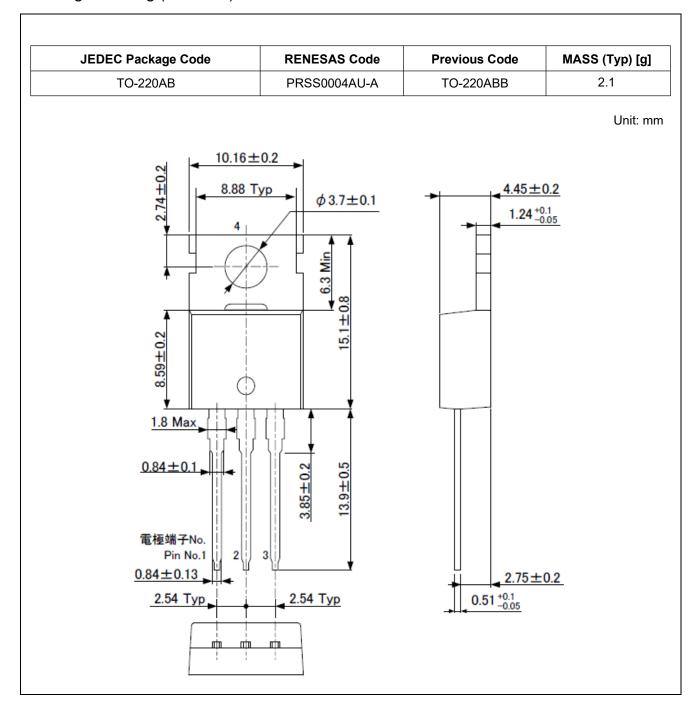
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



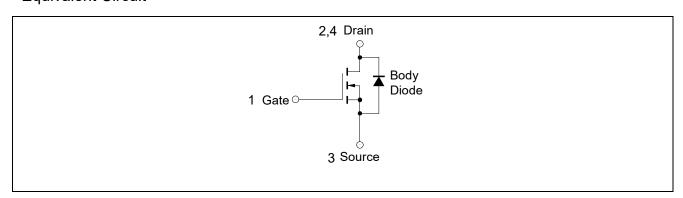
V_{GS} - Gate to Source Voltage - V



Package Drawing (Unit: mm)



Equivalent Circuit



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